



Click [here](#) for the 3D model.

Dimensions

Chip Size	0805
L	2mm -3mm
W	1.25mm +/-0.2mm
T	0.85mm +/-0.2mm
B	0.5mm +/-0.3mm

Packaging Specifications

Packaging	T&R
Packaging Quantity	4000

General Information

Series	Z-SMS
Style	SMD Chip
Description	Chip Bead Signal Line
Features	Suppresses The XL Component; Helps Stop The Reduction Of The Wave-Form Integrity
RoHS	Yes
Notes	Suggested Replacement - https://productfinder.pulseelectronics.com/part/BBGK00201209121Y00 .

Specifications

Impedance	120 Ohms (100 MHz)
Impedance Tolerance	25%
Ripple Current	800 mA (MAX)
Temperature Range	-55/+125°C
DC Resistance	0.15 Ohms